

APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of InventionMETHOD OF FORMING A SEMICONDUCTOR DEVICE HAVING AIR
GAPS AND THE STRUCTURE SO FORMED

Application Type : regular, utility
Attorney Docket Number : BUR920030189US1

Correspondence address:

Customer Number: 30,449



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as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all
business in the United States Patent and Trademark Office connected therewith.

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